1. General description

NPN medium power transistor in a SOT1061 (DFN2020-3) leadless very small Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- High collector current capability I_C and I_{CM}
- Three current gain selections
- · High power dissipation capability
- Exposed heatsink for excellent thermal and electrical conductivity
- Leadless very small SMD plastic package with medium power capability

3. Applications

- Linear voltage regulators
- MOSFET drivers
- Low-side switches
- Power management
- Amplifiers
- · Battery-driven devices



4. Quick reference data

Table 1. Quick reference data

 T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{CEO}	collector-emitter voltage	open base		-	-	80	V
I _C	collector current			-	-	1	Α
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms		-	-	2	Α
h _{FE}	DC current gain			•			
	BC56PA	V _{CE} = 2 V; I _C = 150 mA	[1]	63	-	250	
	BC56-10PA		[1]	63	-	160	
	BC56-16PA		[1]	100	-	250	

^[1] pulsed; $t_p \le 300 \ \mu s; \ \delta \le 0.02$

5. Pinning information

Table 2. Pinning

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	В	base	3	С
2	E	emitter		5 1
3	С	collector		B—
				Ė
			1 2	sym021
			Transparent top view	

6. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
BC56PA	DFN2020-3	plastic, thermal enhanced ultra thin small outline package; no	SOT1061		
BC56-10PA		leads; 3 Terminals; body 2 x 2 x 0.65 mm			
BC56-16PA					

7. Marking

Table 4. Marking

Type number	Marking code
BC56PA	AZ
BC56-10PA	ВК
BC56-16PA	BL

8. Limiting values

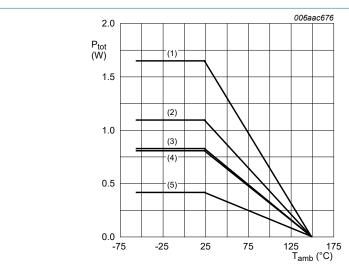
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CBO}	collector-base voltage	open emitter		-	100	V
V _{CEO}	collector-emitter voltage	open base		-	80	V
V _{EBO}	emitter-base voltage	open collector		-	5	V
I _C	collector current			-	1	Α
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms		-	2	Α
I _B	base current			-	0.3	Α
I _{BM}	peak base current	single pulse; t _p ≤ 1 ms		-	0.3	Α
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	0.42	W
			[2]	-	0.83	W
			[3]	-	1.10	W
			[4]	-	0.81	W
			[5]	-	1.65	W
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

- [1] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 1 cm².
- [3] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 6 cm².
- [4] Device mounted on an FR4 PCB; 4-layer copper; tin-plated and standard footprint.
- [5] Device mounted on an FR4 PCB; 4-layer copper; tin-plated; mounting pad for collector 1 cm².



- (1) FR4 PCB, 4-layer copper, mounting pad for collector 1 cm²
- (2) FR4 PCB, single-sided copper, mounting pad for collector 6 cm²
- (3) FR4 PCB, single-sided copper, mounting pad for collector 1 cm²
- (4) FR4 PCB, 4-layer copper, standard footprint
- (5) FR4 PCB, single-sided copper, standard footprint

Fig. 1. Power derating curves SOT1061

BC56PA_SER

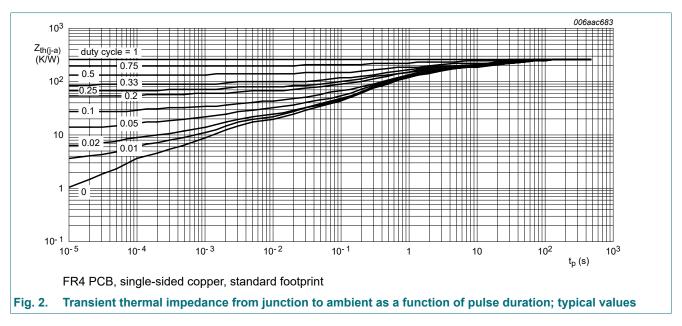
9. Thermal characteristics

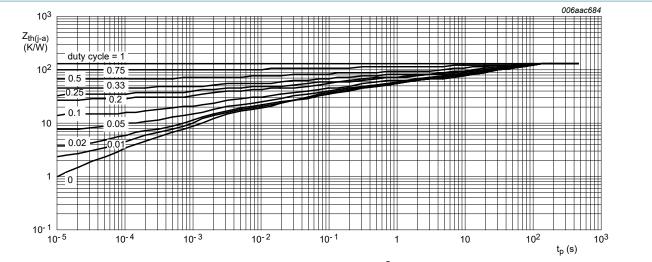
Table 6. Thermal characteristics

 T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1]	-	-	298	K/W
			[2]	-	-	151	K/W
			[3]	-	-	114	K/W
			[4]	-	-	154	K/W
			[5]	-	-	76	K/W
R _(j-sp)	thermal resistance from junction to solder point			-	-	20	K/W

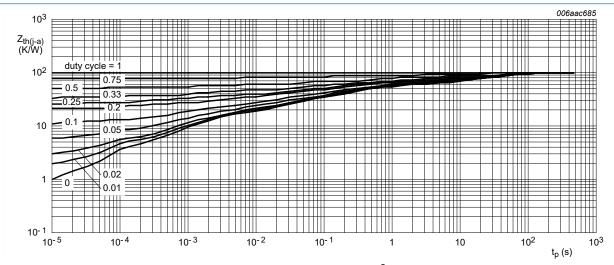
- [1] Device mounted on an FR4 PCB; single-sided copper; tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 1 cm²
- [3] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 6 cm².
- [4] Device mounted on an FR4 PCB; 4-layer copper; tin-plated and standard footprint.
- [5] Device mounted on an FR4 PCB; 4-layer copper; tin-plated; mounting pad for collector 1 cm².





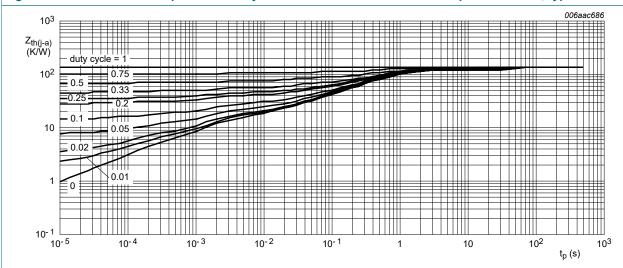
FR4 PCB, single-sided copper, mounting pad for collector 1 cm²

Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, single-sided copper, mounting pad for collector 6 cm²

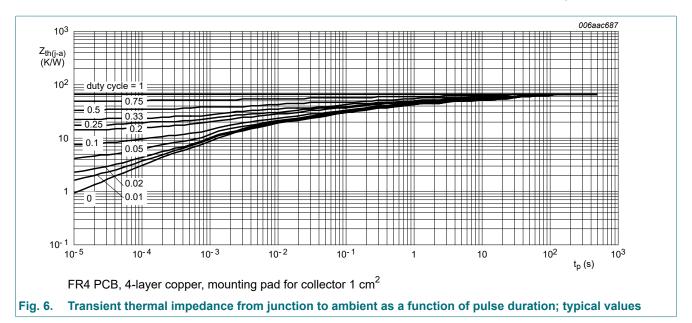
Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, 4-layer copper, standard footprint

Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

80 V, 1 A NPN medium power transistors



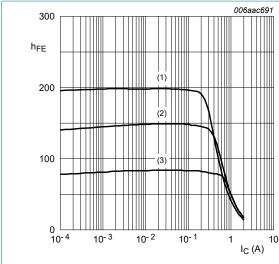
10. Characteristics

Table 7. Characteristics

 T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{(BR)CBO}	collector-base breakdown voltage	I _C = 100 μA; I _E = 0 A		100	-	-	V
V _{(BR)CEO}	collector-emitter breakdown voltage	I _C = 2 mA; I _B = 0 A		80	-	-	V
V _{(BR)EBO}	emitter-base breakdown voltage	I _E = 100 μA; I _C = 0 A		5	-	-	V
I _{CBO}	collector-base	V _{CB} = 30 V; I _E = 0 A		-	-	100	nA
	cut-off current	$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A}; T_j = 150 \text{ °C}$		-	-	10	μΑ
I _{EBO}	emitter-base cut-off current	V _{EB} = 5 V; I _C = 0 A		-	-	100	nA
h _{FE}	DC current gain				'	'	
	BC56PA	V _{CE} = 2 V; I _C = 5 mA	[1]	63	-	-	
		V _{CE} = 2 V; I _C = 150 mA	[1]	63	-	250	
		V _{CE} = 2 V; I _C = 500 mA	[1]	40	-	-	
	BC56-10PA	V _{CE} = 2 V; I _C = 5 mA	[1]	63	-	-	
		V _{CE} = 2 V; I _C = 150 mA	[1]	63	-	160	
		V _{CE} = 2 V; I _C = 500 mA	[1]	40	-	-	
	BC56-16PA	V _{CE} = 2 V; I _C = 5 mA	[1]	63	-	-	
		V _{CE} = 2 V; I _C = 150 mA		100	-	250	
		V _{CE} = 2 V; I _C = 500 mA		40	-	-	
V _{CEsat}	collector-emitter saturation voltage	I _C = 500 mA; I _B = 50 mA	[1]	-	-	500	mV
V_{BE}	base-emitter voltage	V _{CE} = 2 V; I _C = 500 mA	[1]	-	-	1	V
C _c	collector capacitance	V _{CB} = 10 V; I _E = i _e = 0 A; f = 1 MHz		-	6	-	pF
f _T	transition frequency	V _{CE} = 5 V; I _C = 50 mA; f = 100 MHz		100	180	-	MHz

^[1] pulsed; $t_p \le 300 \ \mu s; \ \delta \le 0.02$



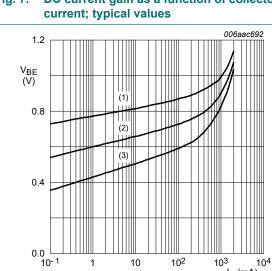
$$V_{CE} = 2 V$$

(1)
$$T_{amb} = 100 \, ^{\circ}C$$

(2)
$$T_{amb}$$
 = 25 °C

(3)
$$T_{amb} = -55$$
 °C

DC current gain as a function of collector Fig. 7. current; typical values



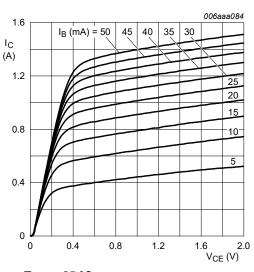
$$V_{CE} = 2 V$$

(1)
$$T_{amb} = -55$$
 °C

(3)
$$T_{amb} = 100 \, ^{\circ}C$$

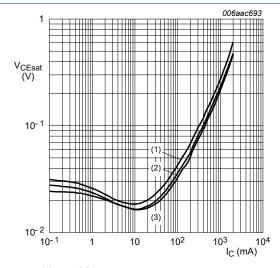
Fig. 9. Base-emitter voltage as a function of collector current; typical values

I_C (mA)



 T_{amb} = 25 °C

Fig. 8. Collector current as a function of collectoremitter voltage; typical values



$$V_{CE} = 2 V$$

(1)
$$T_{amb} = 100 \, ^{\circ}C$$

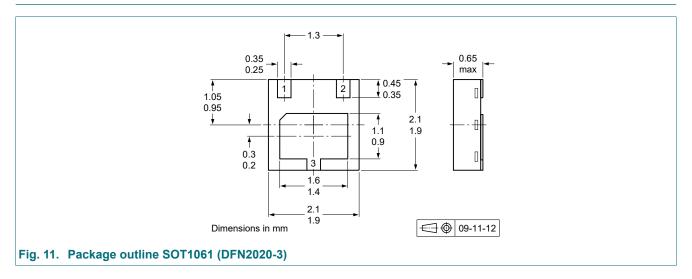
(2)
$$T_{amb}$$
 = 25 °C

(3)
$$T_{amb} = -55 \, ^{\circ}C$$

Fig. 10. Collector-emitter saturation voltage as a function of collector current; typical values

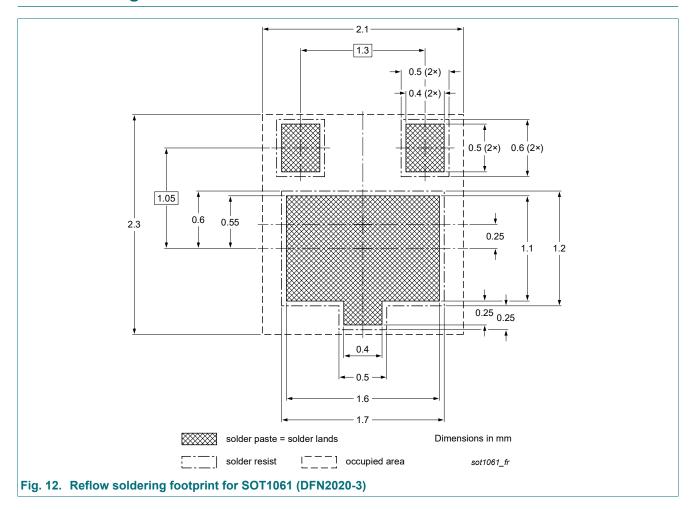
80 V, 1 A NPN medium power transistors

11. Package outline



80 V, 1 A NPN medium power transistors

12. Soldering



80 V, 1 A NPN medium power transistors

13. Revision history

Table 8. Revision history

Table 6. Revision mistory	1	I		I		
Document ID	Release date	Data sheet status	Change notice	Supersedes		
BC56PA_SER v.11	20230701	Product data sheet	-	BC56PA_SER v.10		
Modifications:	 Product(s) changed to non-automotive qualification. Please refer to nexperia.com automotive (-Q) product alternative(s). 					
BC56PA_SER v.10	20220624	Product data sheet	-	BCP56_BCX56_BC56PA v.9		
BCP56_BCX56_BC56PA v.9	20190429	Product data sheet	-	BC639_BCP56_BCX56 v.8		
BC639_BCP56_BCX56 v.8	20160705	Product data sheet	-	BC639_BCP56_BCX56 v.7		
BC639_BCP56_BCX56 v.7		Product data sheet		BC639_BCP56_BCX56 v.6		
BC639_BCP56_BCX56 v.6	20050303	Product data sheet	CPCN2004050 29	BC635_637_639 v.4 BCP54_55_56 v.5 BCX54_55_56 v.4		
BC635_637_639 v.4	20011010	Product specification	-	BC635_637_639 v.3		
BCX54_55_56 v.5	20030206	Product specification	-	BCX54_55_56 v.4		
BCX54_55_56 v.4	20011010	Product specification	-	BCX54_55_56 v.3		

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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